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## **MMBF2202PT1**

**Preferred Device** 

# Power MOSFET 300 mAmps, 20 Volts

P-Channel SC-70/SOT-323

These miniature surface mount MOSFETs low  $R_{DS(on)}$  assure minimal power loss and conserve energy, making these devices ideal for use in small power management circuitry. Typical applications are dc-dc converters, power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

#### Features

- Low R<sub>DS(on)</sub> Provides Higher Efficiency and Extends Battery Life
- Miniature SC-70/SOT-323 Surface Mount Package Saves Board Space
- AEC Qualified
- PPAP Capable
- Pb-Free Package is Available

#### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

Rating	Symbol	Value	Unit
Drain-to-Source Voltage	V <sub>DSS</sub>	20	Vdc
Gate-to-Source Voltage - Continuous	V <sub>GS</sub>	± 20	Vdc
$ \begin{array}{l} \text{Drain Current} \\ - \text{ Continuous } @ \ T_A = 25^\circ\text{C} \\ - \text{ Continuous } @ \ T_A = 70^\circ\text{C} \\ - \text{ Pulsed Drain Current } (t_p \leq 10 \ \mu\text{s}) \end{array} $	I <sub>D</sub> I <sub>D</sub> I <sub>DM</sub>	300 240 750	mAdc
Total Power Dissipation @ $T_A = 25^{\circ}C$ (Note 1) Derate above $25^{\circ}C$	P <sub>D</sub>	150 1.2	mW mW/°C
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	– 55 to 150	°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	833	°C/W
Maximum Lead Temperature for Soldering Purposes, for 10 seconds	ΤL	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

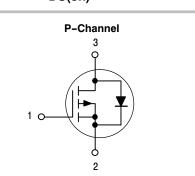
 Mounted on G10/FR4 glass epoxy board using minimum recommended footprint.



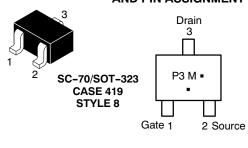
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## 300 mAMPS, 20 VOLTS R<sub>DS(on)</sub> = 2.2 Ω



MARKING DIAGRAM AND PIN ASSIGNMENT



P3 = Specific Device Code M = Date Code\* = Pb-Free Package (Note: Microdot may be in either location)

\*Date Code orientation may vary depending upon manufacturing location.

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MMBF2202PT1	SC-70/ SOT-323	3000 Tape & Reel
MMBF2202PT1G	SC-70/ SOT-323 (Pb-Free)	3000 Tape & Reel

+ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

**Preferred** devices are recommended choices for future use and best overall value.

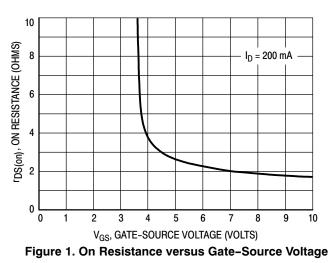
### MMBF2202PT1

#### **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

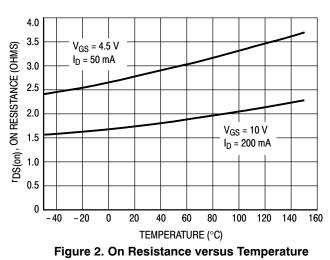
Cha	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltag ( $V_{GS} = 0$ Vdc, $I_D = 10 \mu A$ )	V <sub>(BR)DSS</sub>	20	-	-	Vdc	
Zero Gate Voltage Drain Current ( $V_{DS}$ = 16 Vdc, $V_{GS}$ = 0 Vdc) ( $V_{DS}$ = 16 Vdc, $V_{GS}$ = 0 Vdc, $T_J$	I <sub>DSS</sub>			1.0 10	μAdc	
Gate-Body Leakage Current (V <sub>GS</sub> =	= ± 20 Vdc, V <sub>DS</sub> = 0)	I <sub>GSS</sub>	-	-	±100	nAdc
ON CHARACTERISTICS (Note 2)				•		•
Gate Threshold Voltage ( $V_{DS} = V_{GS}$ , $I_D = 250 \ \mu \text{Adc}$ )		V <sub>GS(th)</sub>	1.0	1.7	2.4	Vdc
$\begin{array}{l} \mbox{Static Drain-to-Source On-Resista} \\ (V_{GS} = 10 \mbox{ Vdc}, \mbox{ I}_{D} = 200 \mbox{ mAdc}) \\ (V_{GS} = 4.5 \mbox{ Vdc}, \mbox{ I}_{D} = 50 \mbox{ mAdc}) \end{array}$	r <sub>DS(on)</sub>		1.5 2.0	2.2 3.5	Ω	
Forward Transconductance (V <sub>DS</sub> =	9FS	-	600	-	mMhos	
DYNAMIC CHARACTERISTICS		L.	•		•	
Input Capacitance	(V <sub>DS</sub> = 5.0 V)	C <sub>iss</sub>	-	50	-	pF
Output Capacitance	(V <sub>DS</sub> = 5.0 V)	C <sub>oss</sub>	-	45	-	
Transfer Capacitance	(V <sub>DG</sub> = 5.0 V)	C <sub>rss</sub>	-	20	-	
SWITCHING CHARACTERISTICS	(Note 3)	L.	•		•	
Turn-On Delay Time		t <sub>d(on)</sub>	-	2.5	-	ns
Rise Time	$(V_{DD} = -15 \text{ Vdc},$	t <sub>r</sub>	-	1.0	-	
Turn-Off Delay Time	R <sub>L</sub> = 75 Ω, I <sub>D</sub> = 200 mAdc, V <sub>GEN</sub> = −10 V, R <sub>G</sub> = 6.0 Ω)	t <sub>d(off)</sub>	-	16	-	]
Fall Time		t <sub>f</sub>	-	8.0	-	
Gate Charge (See Figure 5)	$(V_{DS} = 16 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 200 \text{ mA})$	Q <sub>T</sub>	-	2700	-	рС
SOURCE-DRAIN DIODE CHARAC	TERISTICS		•	•	-	•
Continuous Current	۱ <sub>S</sub>	-	-	0.3	А	
Pulsed Current	I <sub>SM</sub>	-	-	0.75	1	
Forward Voltage (Note 3)	V <sub>SD</sub>	-	1.5	-	V	

2. Pulse Test: Pulse Width  $\leq$  300 µs, Duty Cycle  $\leq$  2%.

3. Switching characteristics are independent of operating junction temperature.



#### **TYPICAL CHARACTERISTICS**



#### **MMBF2202PT1**

#### **TYPICAL CHARACTERISTICS**

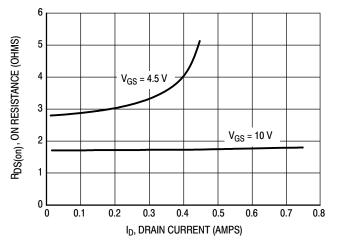
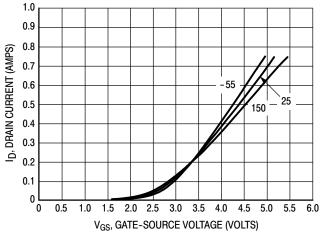


Figure 3. On Resistance versus Drain Current





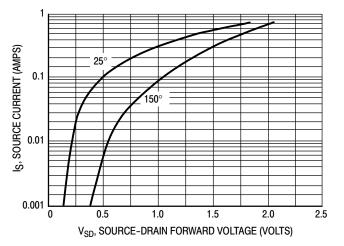
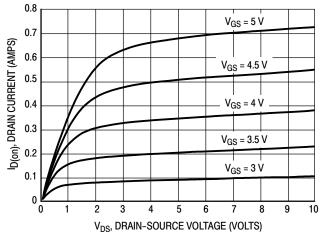


Figure 5. Source-Drain Forward Voltage



#### Figure 6. On Region Characteristics

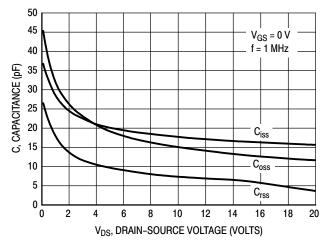
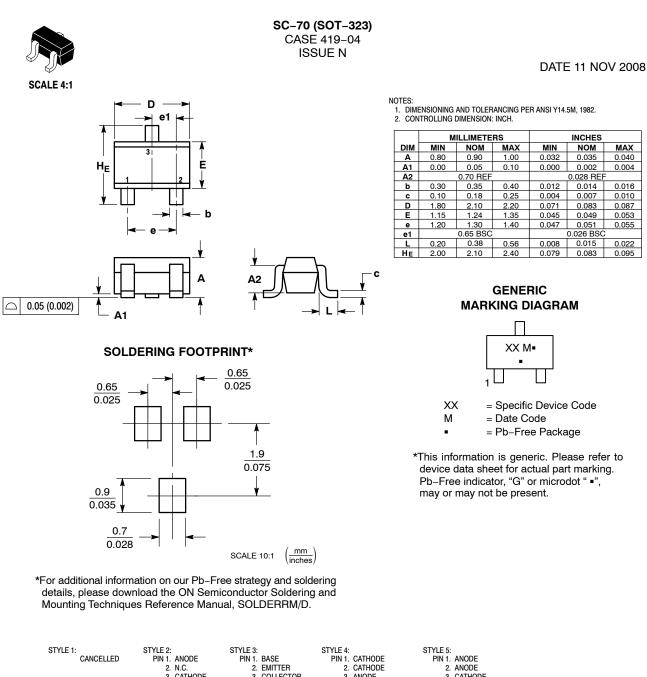


Figure 7. Capacitance Variation





		3. CATHODE	3. COLLECTOR	3. ANODE	3. CATHODE	
3. COLLECTOR 3. COLLECTOR 3. DRAIN 3. CATHODE-ANODE 3. ANODE-CATHODE 3. CATHOD	PIN 1. EMITTER 2. BASE	PIN 1. BASE 2. EMITTER	PIN 1. GATE 2. SOURCE	PIN 1. ANODE 2. CATHODE	PIN 1. CATHODE 2. ANODE	STYLE 11: PIN 1. CATHODE 2. CATHODE 3. CATHODE

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